

BFR92AW

NPN 5 GHz wideband transistor

Rev. 03 — 12 March 2008

Product data sheet

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NXP Semiconductors

NPN 5 GHz wideband transistor

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FEATURES

- High power gain
- Gold metallization ensures excellent reliability
- SOT323 (S-mini) package.

APPLICATIONS

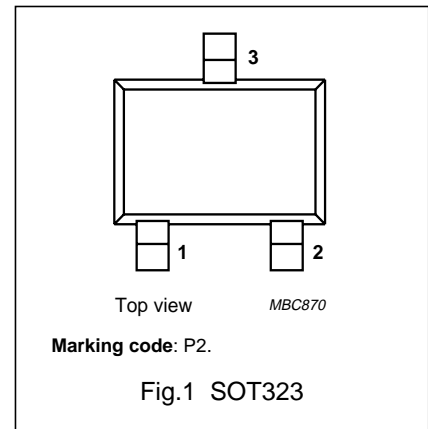
It is designed for use in RF amplifiers, mixers and oscillators with signal frequencies up to 1 GHz.

DESCRIPTION

Silicon NPN transistor encapsulated in a plastic SOT323 (S-mini) package. The BFR92AW uses the same crystal as the SOT23 version, BFR92A.

PINNING

PIN	DESCRIPTION
1	base
2	emitter
3	collector



QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	–	20	V
V_{CEO}	collector-emitter voltage	open base	–	–	15	V
I_C	collector current (DC)		–	–	25	mA
P_{tot}	total power dissipation	up to $T_s = 93\text{ °C}$; note 1	–	–	300	mW
h_{FE}	current gain	$I_C = 15\text{ mA}$; $V_{CE} = 10\text{ V}$	65	90	135	
C_{re}	feedback capacitance	$I_C = 0$; $V_{CE} = 10\text{ V}$; $f = 1\text{ MHz}$; $T_{amb} = 25\text{ °C}$	–	0.35	–	pF
f_T	transition frequency	$I_C = 15\text{ mA}$; $V_{CE} = 10\text{ V}$; $f = 500\text{ MHz}$	3.5	5	–	GHz
G_{UM}	maximum unilateral power gain	$I_C = 15\text{ mA}$; $V_{CE} = 10\text{ V}$; $f = 1\text{ GHz}$; $T_{amb} = 25\text{ °C}$	–	14	–	dB
		$I_C = 15\text{ mA}$; $V_{CE} = 10\text{ V}$; $f = 2\text{ GHz}$; $T_{amb} = 25\text{ °C}$	–	8	–	dB
F	noise figure	$I_C = 5\text{ mA}$; $V_{CE} = 10\text{ V}$; $f = 1\text{ GHz}$; $\Gamma_s = \Gamma_{opt}$	–	2	–	dB
T_j	junction temperature		–	–	150	°C

Note

1. T_s is the temperature at the soldering point of the collector pin.

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LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).

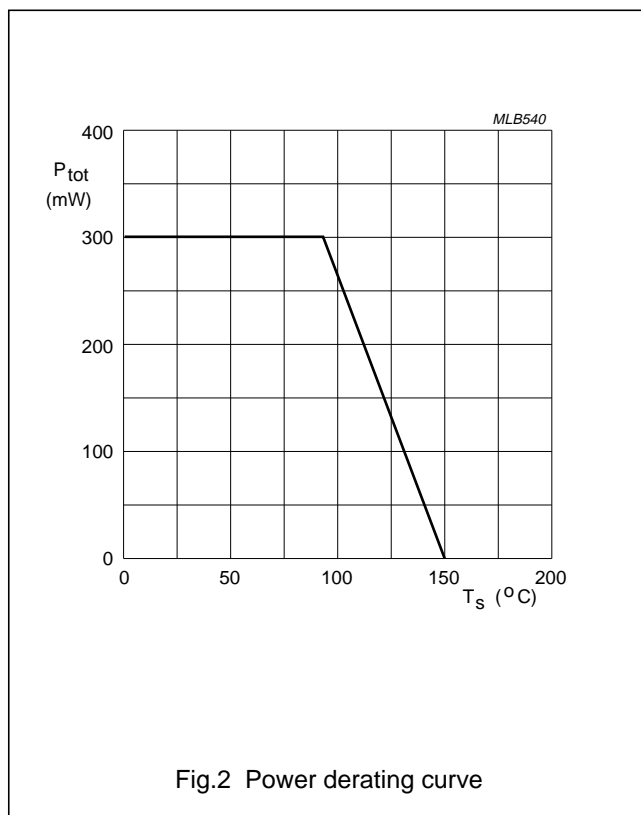
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	–	20	V
V _{CEO}	collector-emitter voltage	open base	–	15	V
V _{EBO}	emitter-base voltage	open collector	–	2	V
I _C	collector current (DC)		–	25	mA
P _{tot}	total power dissipation	up to T _s = 93 °C; see Fig.2; note 1	–	300	mW
T _{stg}	storage temperature		–65	+150	°C
T _j	junction temperature		–	150	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-s}	thermal resistance from junction to soldering point	up to T _s = 93 °C; note 1	190	K/W

Note to the Limiting values and Thermal characteristics

1. T_s is the temperature at the soldering point of the collector pin.



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CHARACTERISTICS

$T_j = 25\text{ °C}$ (unless otherwise specified).

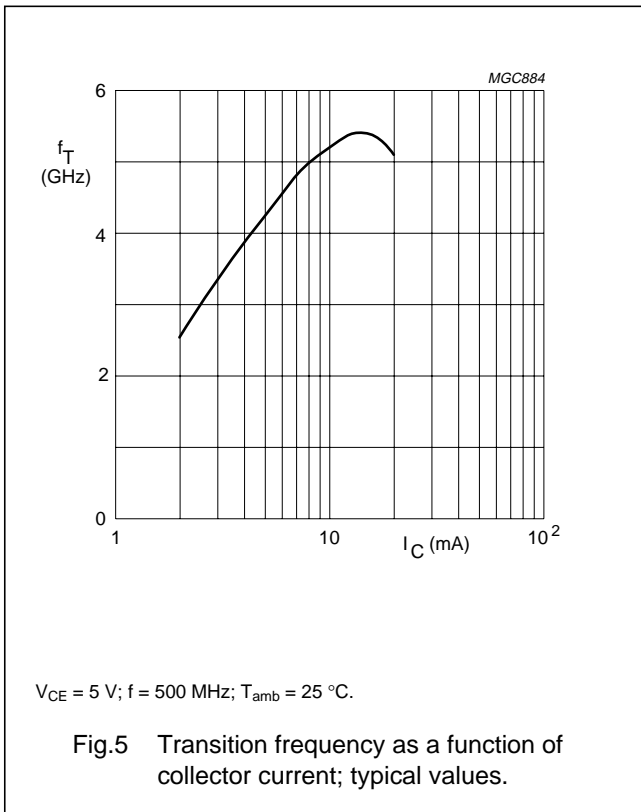
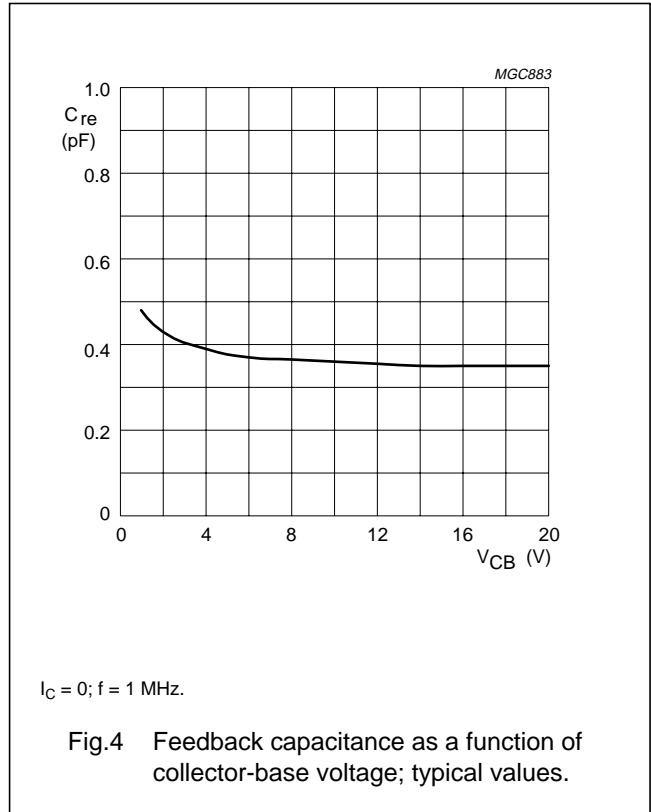
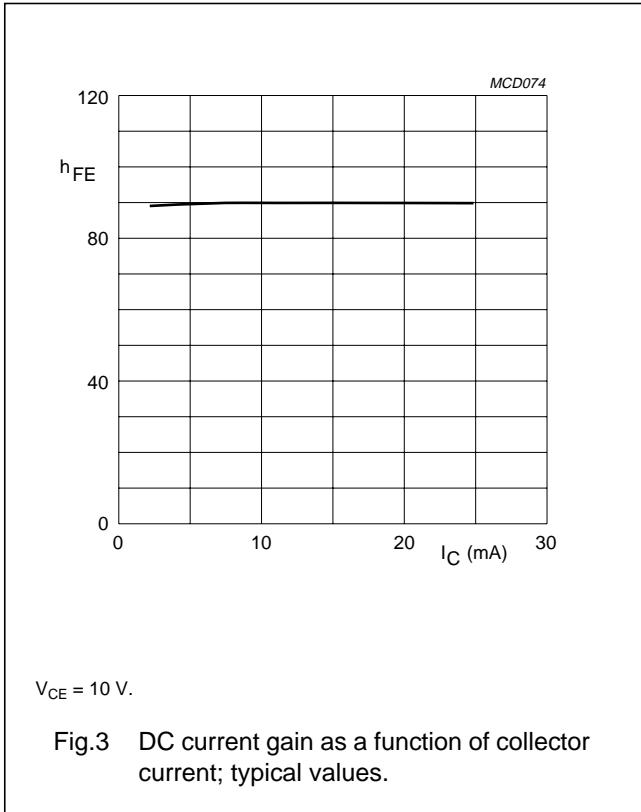
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{CBO}	collector leakage current	$I_E = 0; V_{CB} = 10\text{ V}$	–	–	50	nA
h_{FE}	DC current gain	$I_C = 15\text{ mA}; V_{CE} = 10\text{ V}$	65	90	135	
C_c	collector capacitance	$I_E = i_e = 0; V_{CB} = 10\text{ V}; f = 1\text{ MHz}$	–	0.6	–	pF
C_e	emitter capacitance	$I_C = i_c = 0; V_{EB} = 0.5\text{ V}; f = 1\text{ MHz}$	–	0.9	–	pF
C_{re}	feedback capacitance	$I_C = 0; V_{CE} = 10\text{ V}; f = 1\text{ MHz}$	–	0.35	–	pF
f_T	transition frequency	$I_C = 15\text{ mA}; V_{CE} = 10\text{ V}; f = 500\text{ MHz}$	3.5	5	–	GHz
G_{UM}	maximum unilateral power gain; note 1	$I_C = 15\text{ mA}; V_{CE} = 10\text{ V};$ $f = 1\text{ GHz}; T_{amb} = 25\text{ °C}$	–	14	–	dB
		$I_C = 15\text{ mA}; V_{CE} = 10\text{ V};$ $f = 2\text{ GHz}; T_{amb} = 25\text{ °C}$	–	8	–	dB
F	noise figure	$I_C = 5\text{ mA}; V_{CE} = 10\text{ V};$ $f = 1\text{ GHz}; \Gamma_s = \Gamma_{opt}$	–	2	–	dB
		$I_C = 5\text{ mA}; V_{CE} = 10\text{ V};$ $f = 2\text{ GHz}; \Gamma_s = \Gamma_{opt}$	–	3	–	dB

Note

1. G_{UM} is the maximum unilateral power gain, assuming s_{12} is zero and $G_{UM} = 10 \log \frac{|s_{21}|^2}{(1 - |s_{11}|^2)(1 - |s_{22}|^2)}$ dB.

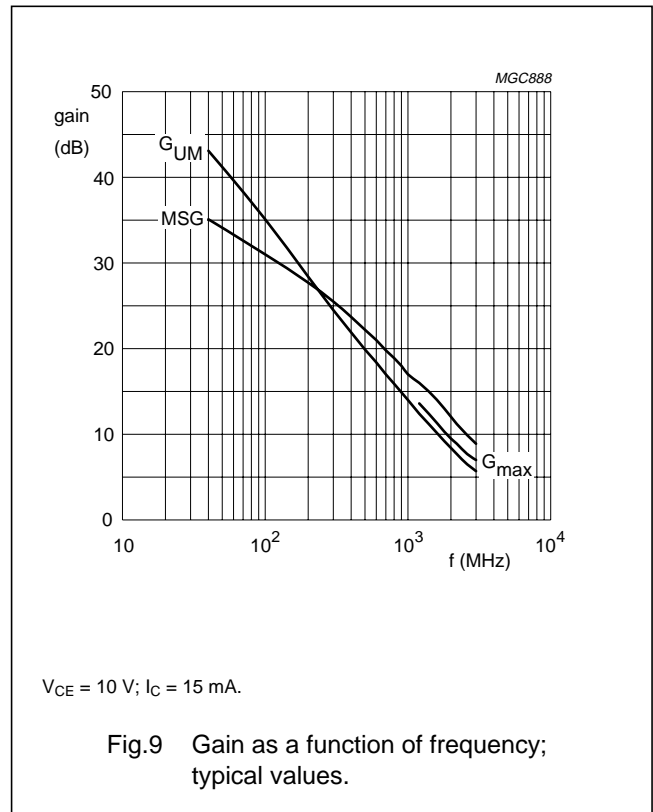
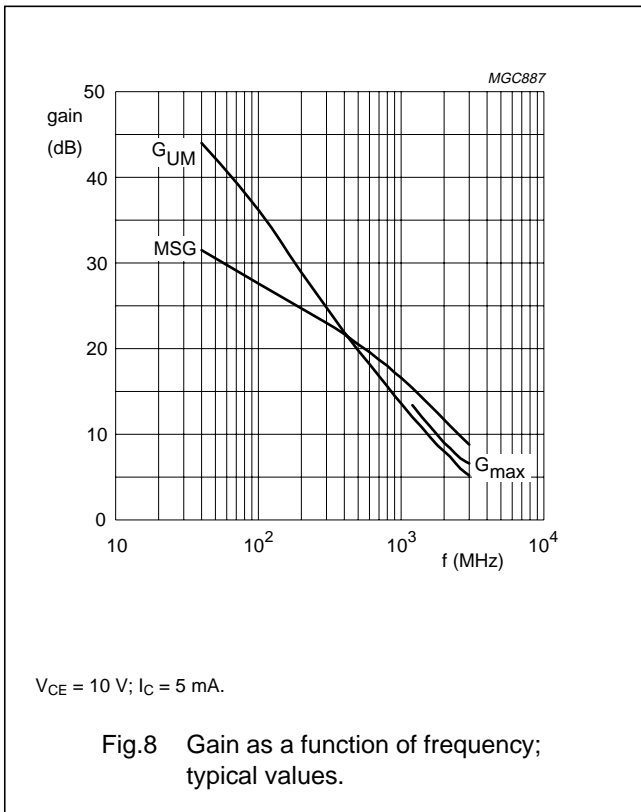
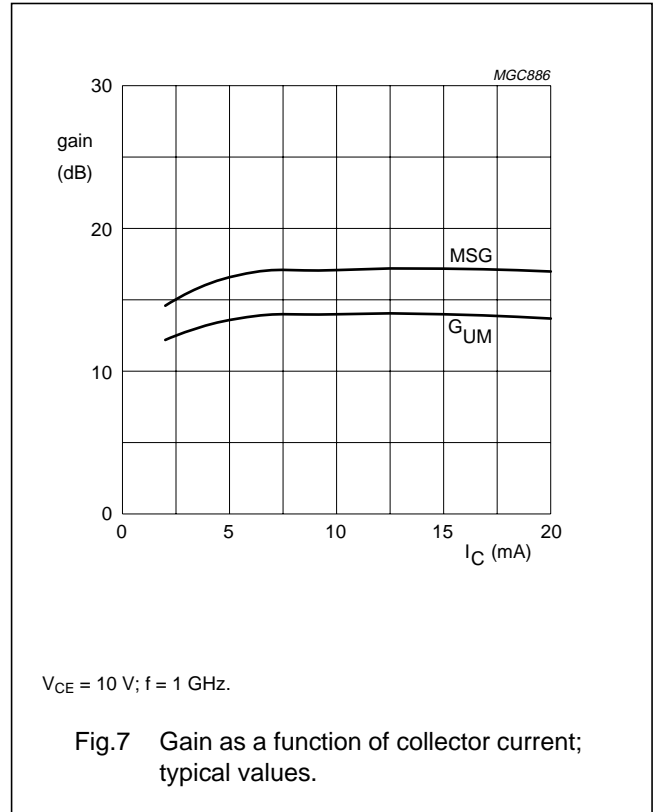
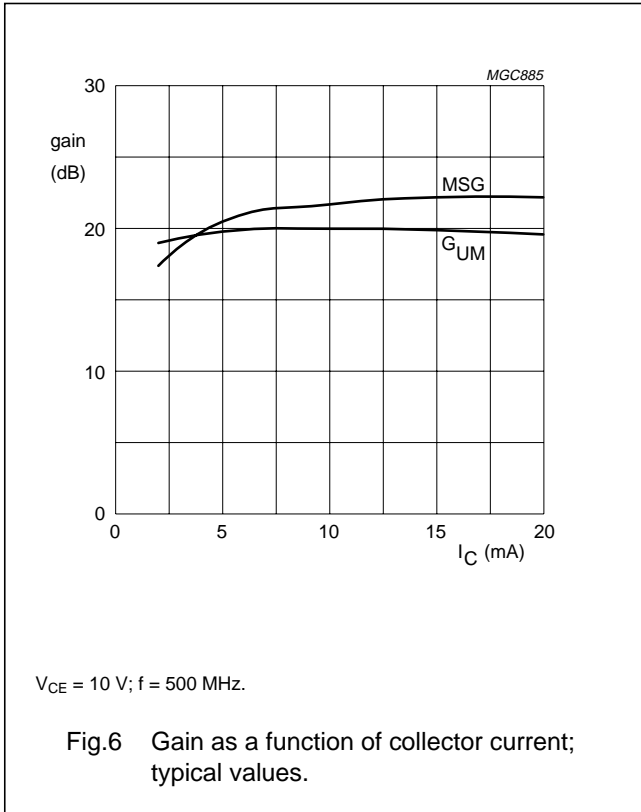
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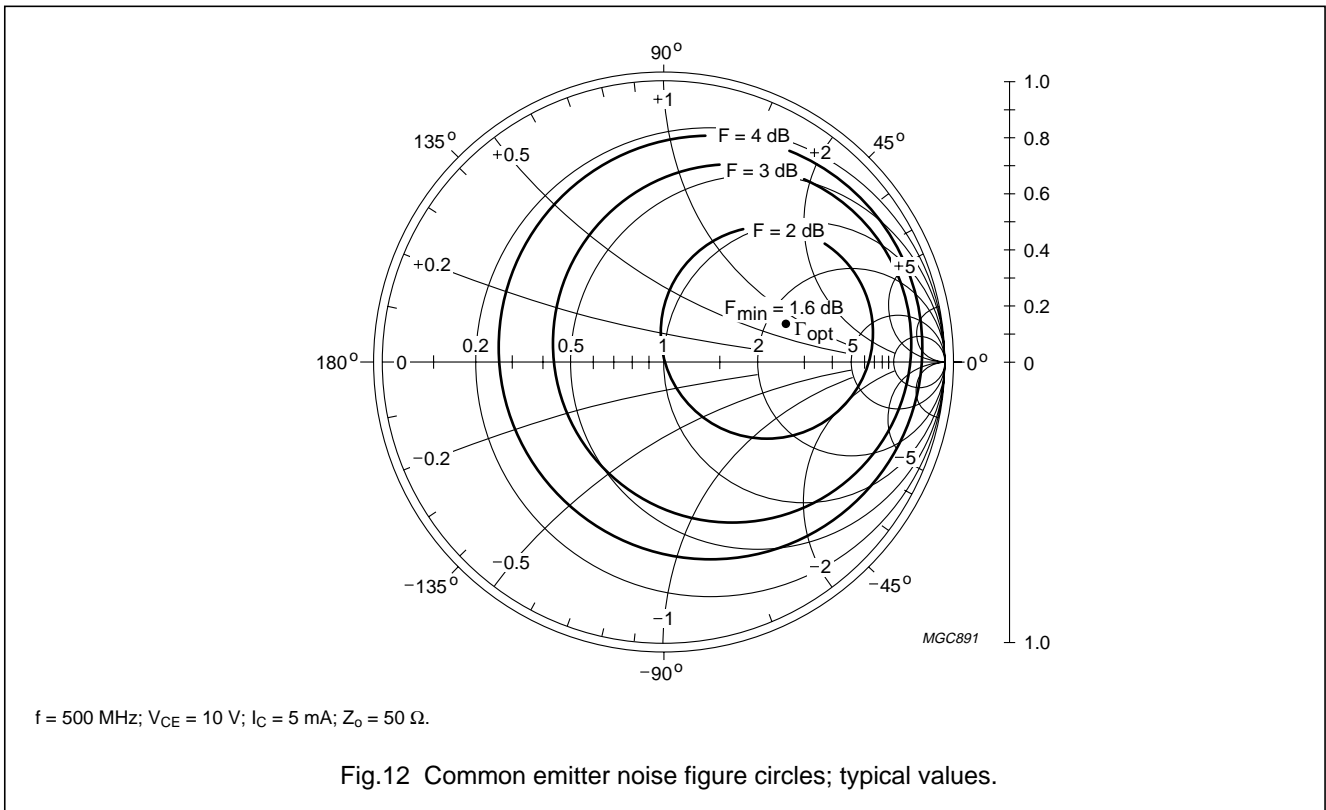
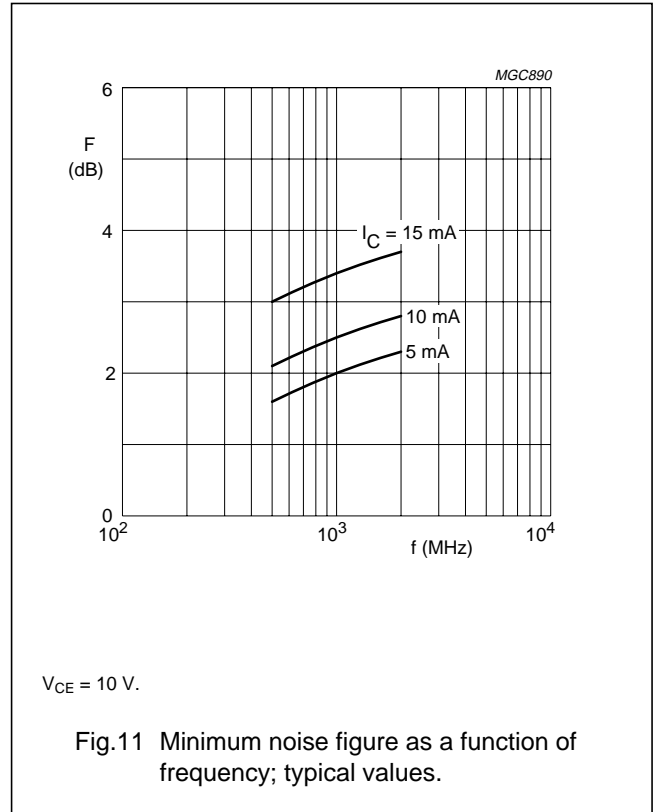
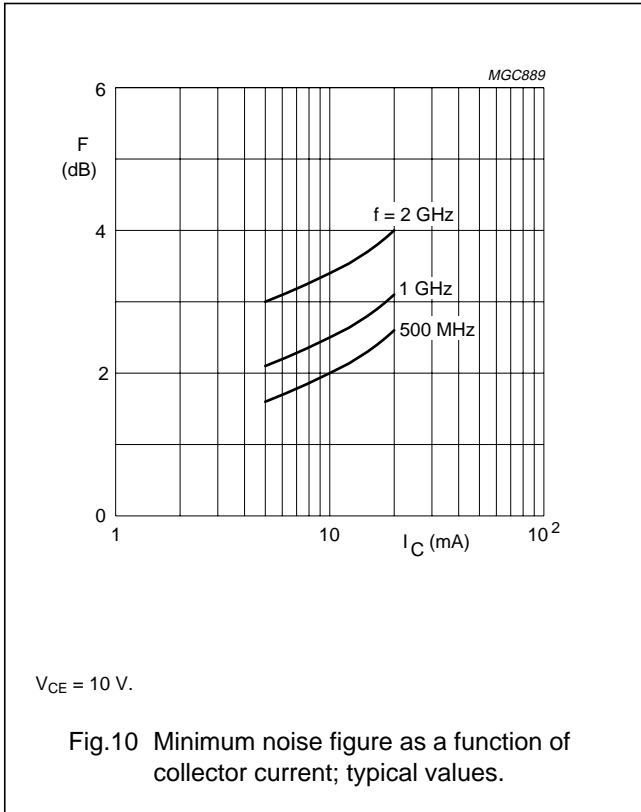
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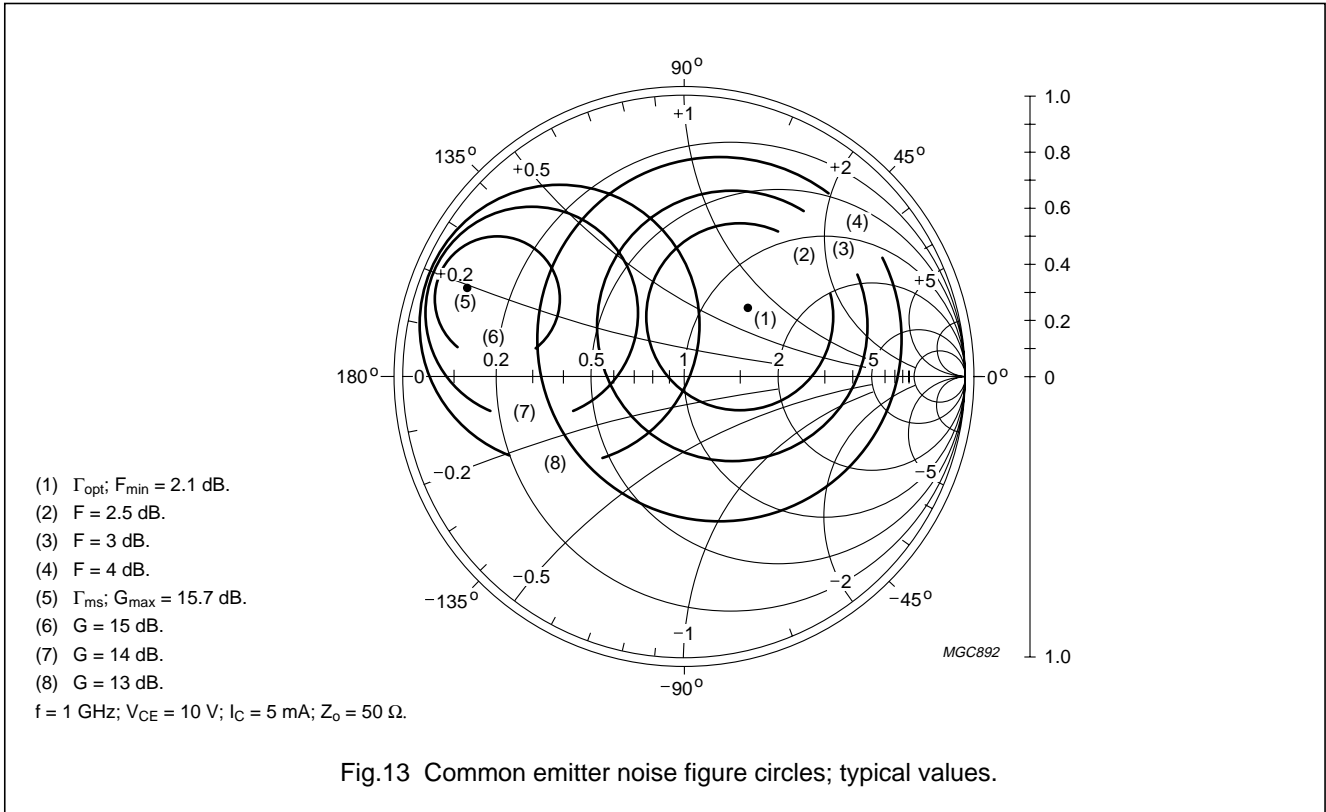


Fig.13 Common emitter noise figure circles; typical values.

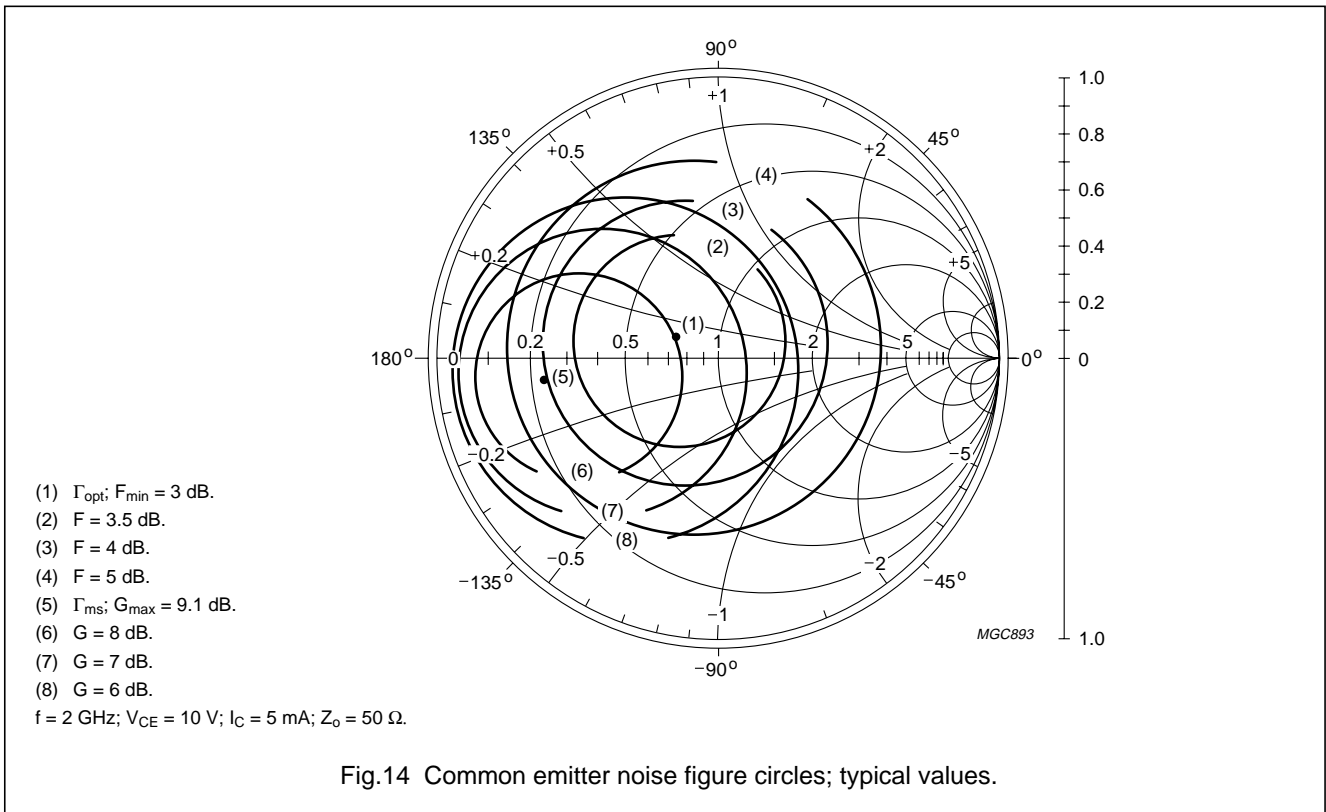
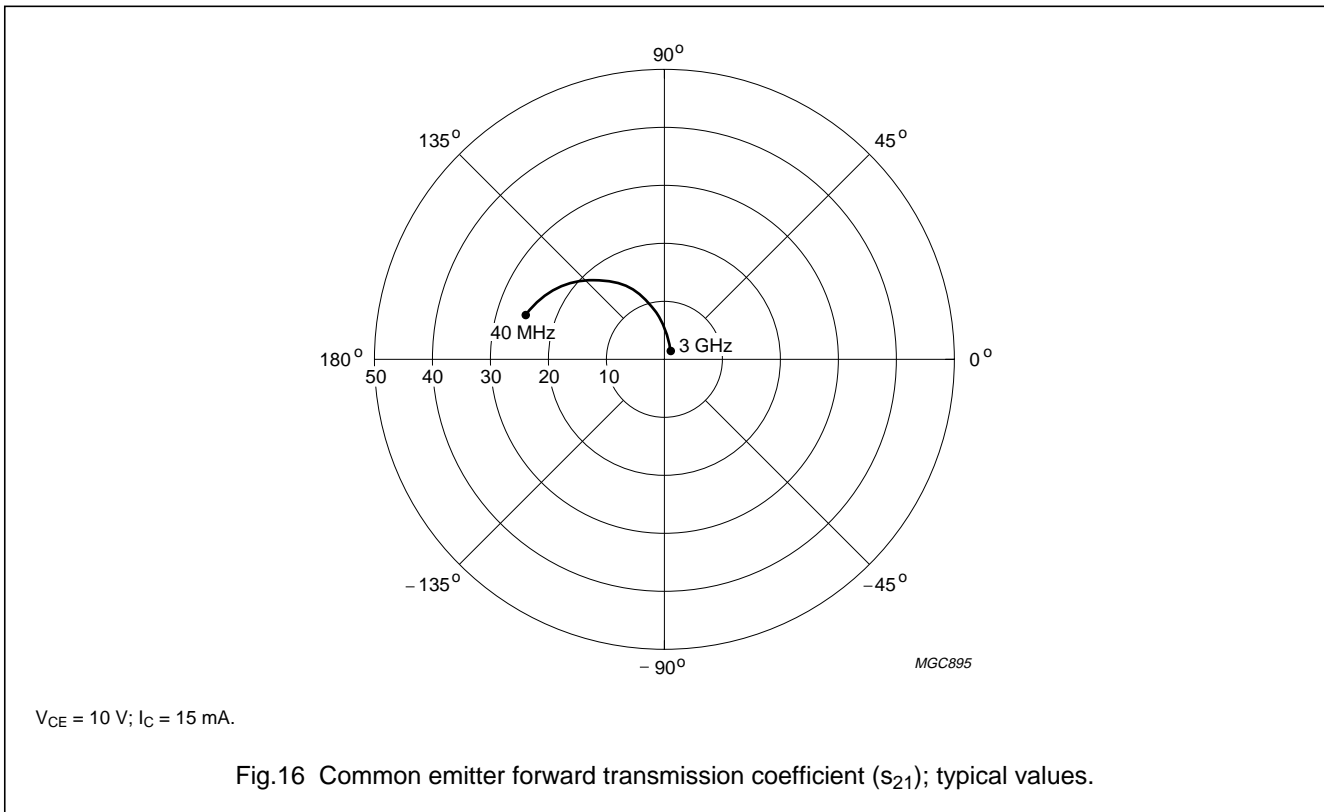
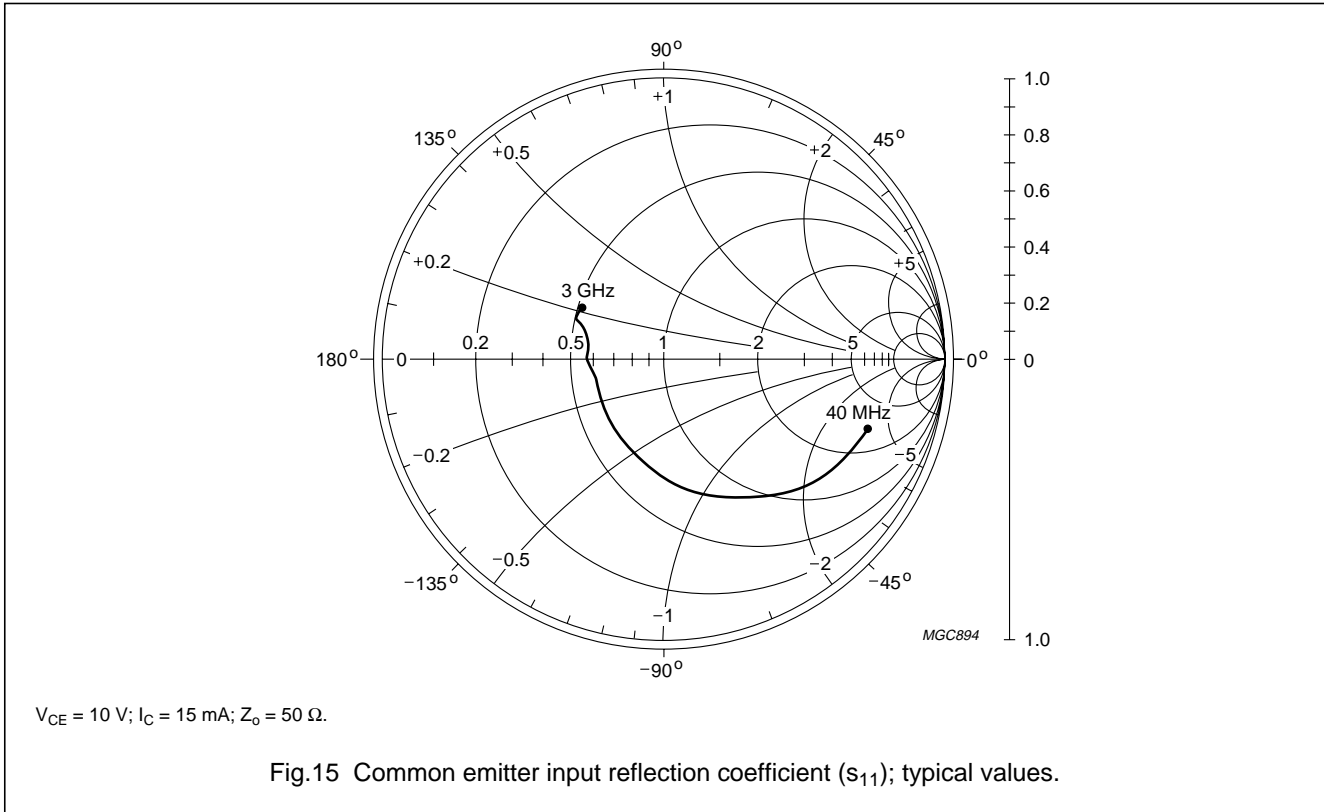


Fig.14 Common emitter noise figure circles; typical values.

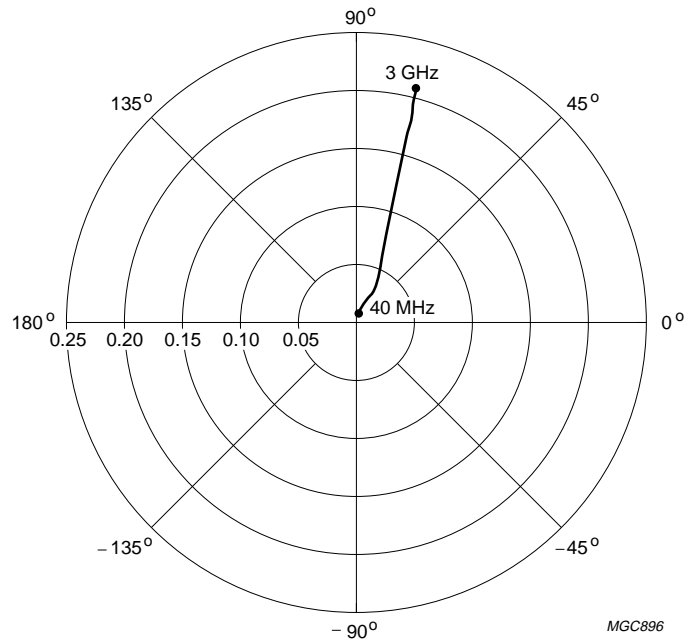
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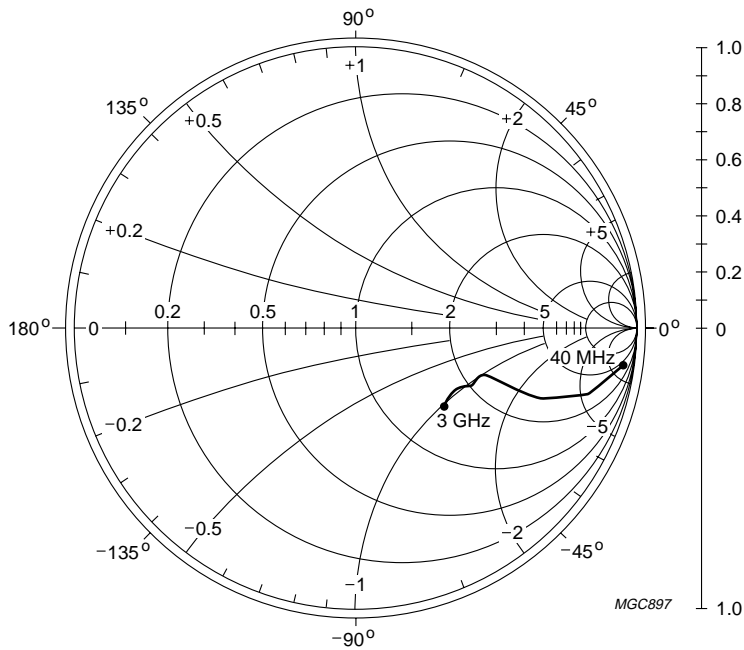
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MGC896

$V_{CE} = 10\text{ V}$; $I_C = 15\text{ mA}$.

Fig.17 Common emitter reverse transmission coefficient (s_{12}); typical values.



MGC897

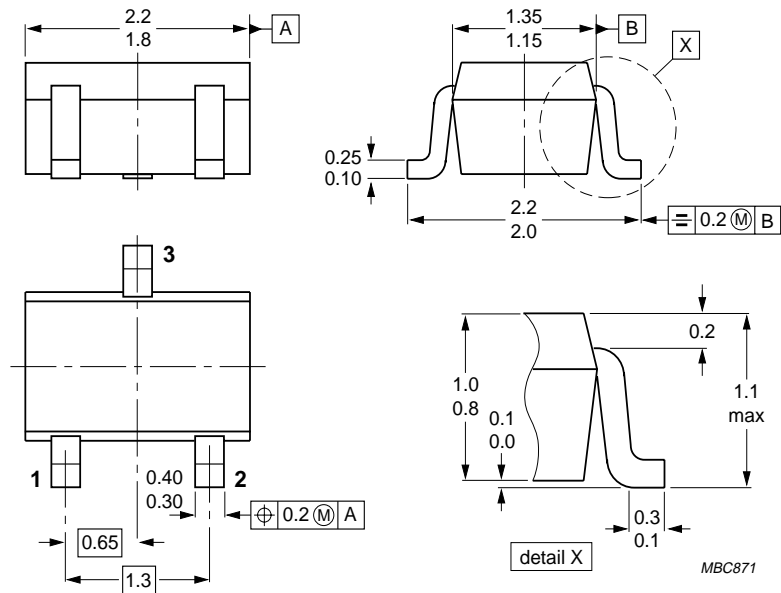
$V_{CE} = 10\text{ V}$; $I_C = 15\text{ mA}$; $Z_o = 50\ \Omega$.

Fig.18 Common emitter output reflection coefficient (s_{22}); typical values.

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PACKAGE OUTLINE



Dimensions in mm.

Fig.19 SOT323.

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Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Revision history

Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BFR92AW_N_3	20080312	Product data sheet	-	BFR92AW_2
Modifications:	• Quick reference data and Characteristics Table; DC current gain value changed			
BFR92AW_2	19950918	Product specification	-	BFR92AW_1
BFR92AW_1	19921001	-	-	-

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